



### 30V P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(on) max</sub>        | I <sub>D</sub><br>T <sub>A</sub> = 25°C |
|----------------------|--------------------------------|---|
|                      | $50m\Omega$ @ $V_{GS} = -10V$  | -3.7A                                   |
| -30V                 | $60m\Omega$ @ $V_{GS} = -4.5V$ | -3.3A                                   |
|                      | 85mΩ @ $V_{GS} = -2.5V$        | -2.7A                                   |

# Description

This new generation Small-Signal enhancement mode MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

## **Applications**

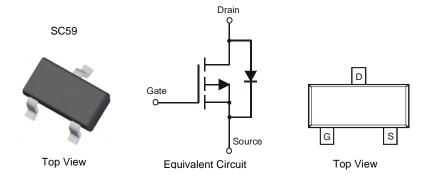
- Motor control
- Backlighting
- DC-DC Converters
- Power management functions

### **Features**

- Low Input Capacitance
- Low On-Resistance
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SC59
- Case Material: Molded Plastic "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Weight: 0.008 grams (approximate)



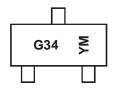
## Ordering Information (Note 4)

| Part Number  | Case | Packaging        |  |
|--------------|------|------------------|--|
| DMG3401LSN-7 | SC59 | 3000/Tape & Reel |  |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**



G34 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

| Year  | 2011 | 1   | 2012 |     | 2013 | 20  | 14  | 2015 |     | 2016 | - : | 2017 |
|-------|------|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code  | Υ    |     | Z    |     | Α    |     | 3   | С    |     | D    |     | Е    |
| Month | Jan  | Feb | Mar  | Apr | May  | Jun | Jul | Aug  | Sep | Oct  | Nov | Dec  |
| Code  | 1    | 2   | 3    | 4   | 5    | 6   | 7   | 8    | 9   | 0    | N   | D    |

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# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic   | Symbol          | Value                            | Units          |              |   |
|--|-----------------|----------------------------------|----------------|--------------|---|
| Drain-Source Voltage                                     | $V_{DSS}$       | -30                              | V              |              |   |
| Gate-Source Voltage                                      | $V_{GSS}$       | ±12                              | V              |              |   |
| Continuous Drain Current (Note 5) V <sub>GS</sub> = -10V | Steady<br>State | $T_A = +25$ °C<br>$T_A = +70$ °C | l <sub>D</sub> | -3.0<br>-2.3 | А |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V | I <sub>D</sub>  | -3.7<br>-2.9                     | А              |              |   |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%)       | I <sub>DM</sub> | -30                              | Α              |              |   |
| Maximum Body Diode Continuous Current (Note 6)           | I <sub>S</sub>  | -1.5                             | Α              |              |   |

## **Thermal Characteristics**

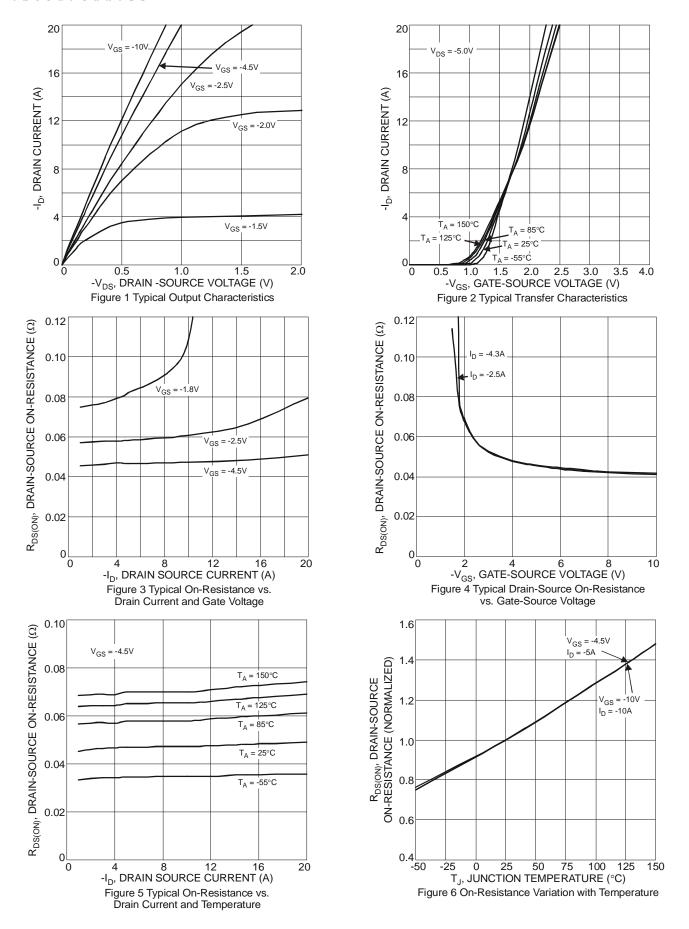
| Characteristic                          |          | Symbol            | Value       | Units |  |
|---|----------|-------------------|-------------|-------|--|
| Total Power Dissipation                 | (Note 5) | D-                | 0.8         | W     |  |
| Total Power Dissipation                 | (Note 6) | P <sub>D</sub>    | 1.2         |       |  |
| Thermal Desistance, Junction to Ambient | (Note 5) | Б                 | 159         | ,     |  |
| Thermal Resistance, Junction to Ambient | (Note 6) | $R_{\theta JA}$   | 105         | °C/W  |  |
| Thermal Resistance, Junction to Case    | (Note 6) | $R_{\theta JC}$   | 36          |       |  |
| Operating and Storage Temperature Range |          | $T_{J_i} T_{STG}$ | -55 to +150 | °C    |  |

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

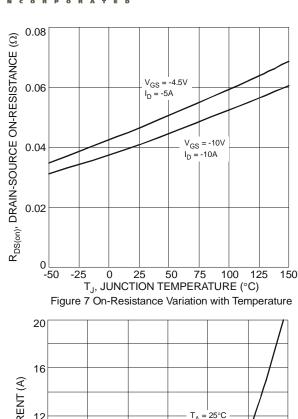
| Characteristic  | Symbol               | Min  | Тур   | Max  | Unit  | Test Condition                                 |  |
|---|----------------------|------|-------|------|-------|--|--|
| OFF CHARACTERISTICS (Note 7)                          |                      |      | - 71- |      |       |  |  |
| Drain-Source Breakdown Voltage                        | BV <sub>DSS</sub>    | -30  | -     | -    | V     | $V_{GS} = 0V, I_D = -250\mu A$                 |  |
| Zero Gate Voltage Drain Current T <sub>J</sub> = 25°C | I <sub>DSS</sub>     | -    | -     | -1.0 | μΑ    | $V_{DS} = -30V, V_{GS} = 0V$                   |  |
| Gate-Body Leakage                                     | I <sub>GSS</sub>     | -    | -     | ±100 | nA    | $V_{GS} = \pm 12V, V_{DS} = 0V$                |  |
| ON CHARACTERISTICS (Note 7)                           |                      |      |       |      |       |  |  |
| Gate Threshold Voltage                                | V <sub>GS(th)</sub>  | -0.5 | -1.0  | -1.3 | V     | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$          |  |
|   |                      | -    | 41    | 50   |       | $V_{GS} = -10V, I_D = -4A$                     |  |
| Static Drain-Source On-Resistance                     | R <sub>DS (ON)</sub> | -    | 47    | 60   | mΩ    | $V_{GS} = -4.5V, I_D = -3.5A$                  |  |
|   |                      | -    | 60    | 85   |       | $V_{GS} = -2.5V, I_D = -2.5A$                  |  |
| Forward Transfer Admittance                           | Y <sub>fs</sub>      | -    | 12    | -    | S     | $V_{DS} = -5V, I_{D} = -4A$                    |  |
| Diode Forward Voltage                                 | V <sub>SD</sub>      | -    | -0.8  | -1.0 | V     | V <sub>GS</sub> = 0V, I <sub>S</sub> = -1A     |  |
| DYNAMIC CHARACTERISTICS (Note 8)                      |                      |      |       |      |       |  |  |
| Input Capacitance                                     | C <sub>iss</sub>     | -    | 1326  | -    |       |  |  |
| Output Capacitance                                    | Coss                 | -    | 103   | -    | pF    | $V_{DS} = -15V$ , $V_{GS} = 0V$ , $f = 1.0MHz$ |  |
| Reverse Transfer Capacitance                          | C <sub>rss</sub>     | ı    | 71    | -    |       |  |  |
| Gate Resistance                                       | Rg                   | -    | 7.3   | -    | Ω     | $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$         |  |
| Total Gate Charge (V <sub>GS</sub> = -4.5V)           | Qg                   | -    | 11.6  | -    |       |  |  |
| Total Gate Charge (V <sub>GS</sub> = -10V)            | Qg                   | -    | 25.1  | -    | nC    | 15)/ 1 10                                      |  |
| Gate-Source Charge                                    | $Q_{gs}$             | -    | 2     | -    | nc nc | $V_{DD} = -15V, I_{D} = -4A$                   |  |
| Gate-Drain Charge                                     | $Q_{gd}$             | -    | 1.7   | -    |       |  |  |
| Turn-On Delay Time                                    | t <sub>D(on)</sub>   | -    | 8     | -    |       |  |  |
| Turn-On Rise Time                                     | t <sub>r</sub>       | -    | 13    | -    | nS    | $V_{DS} = -15V, V_{GS} = -10V,$                |  |
| Turn-Off Delay Time                                   | t <sub>D(off)</sub>  | -    | 71    | -    | 110   | $R_{GEN} = 6\Omega$ , $R_L = 3.75\Omega$       |  |
| Turn-Off Fall Time                                    | t <sub>f</sub>       | -    | 38    | -    |       |  |  |

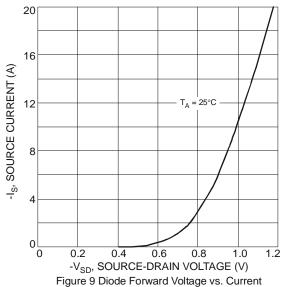
- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout
- 7 .Short duration pulse test used to minimize self-heating effect.
  8. Guaranteed by design. Not subject to production testing

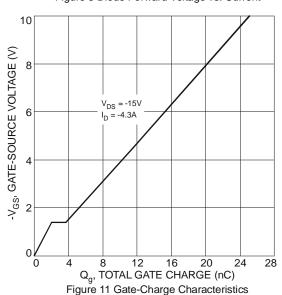












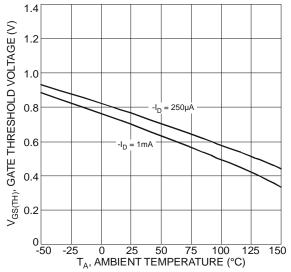
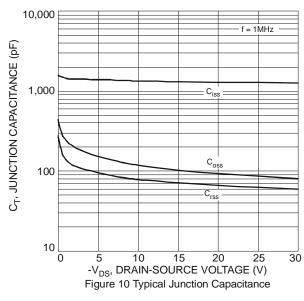
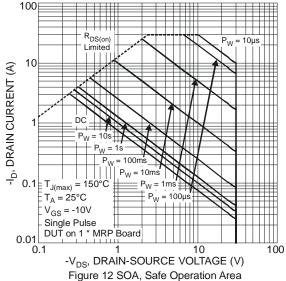
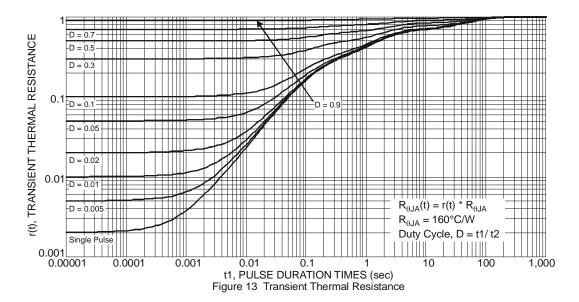


Figure 8 Gate Threshold Variation vs. Ambient Temperature



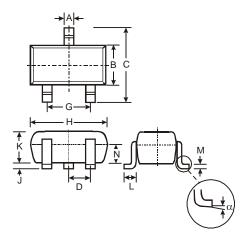






# **Package Outline Dimensions**

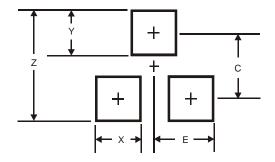
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SC59 |                      |            |      |  |  |  |  |  |
|------|----------------------|------------|------|--|--|--|--|--|
| Dim  | Min                  | Max        | Тур  |  |  |  |  |  |
| Α    | 0.35                 | 0.50       | 0.38 |  |  |  |  |  |
| В    | 1.50                 | 1.70       | 1.60 |  |  |  |  |  |
| С    | 2.70                 | 3.00       | 2.80 |  |  |  |  |  |
| D    | -                    | -          | 0.95 |  |  |  |  |  |
| G    | -                    | -          | 1.90 |  |  |  |  |  |
| Н    | 2.90                 | 2.90 3.10  |      |  |  |  |  |  |
| J    | 0.013                | 0.013 0.10 |      |  |  |  |  |  |
| K    | 1.00                 | 1.30       | 1.10 |  |  |  |  |  |
| L    | 0.35                 | 0.55       | 0.40 |  |  |  |  |  |
| M    | 0.10                 | 0.20       | 0.15 |  |  |  |  |  |
| N    | 0.70                 | 0.80       | 0.75 |  |  |  |  |  |
| α    | 0°                   | 8°         | -    |  |  |  |  |  |
| All  | All Dimensions in mm |            |      |  |  |  |  |  |

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 3.4           |
| Х          | 0.8           |
| Υ          | 1.0           |
| С          | 2.4           |
| E          | 1.35          |



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